

# Agnel Jenson A. Paul

Champaign, IL 61820 | (217) 766-8463 | [aja14@illinois.edu](mailto:aja14@illinois.edu) | [linkedin.com/in/agneljenson](https://www.linkedin.com/in/agneljenson)

## EDUCATION

### University of Illinois at Urbana-Champaign

Urbana, IL

*Master of Engineering (MEng) in Mechanical Engineering*

Expected Graduation December 2024

Coursework: Design for Six Sigma, Data Science in Manufacturing Quality Control and Electronics Cooling

### NMIMS University

Mumbai, India

*Bachelor of Technology (BTech) in Mechanical Engineering*

Graduated May 2023

*Master of Business Administration (MBA) in Technology Management (dual degree)*

Minors in Operations-Supply Chain Management and Business Analytics

## SKILLS

- **Tools:** ANSYS Icepak, AutoCAD, Siemens NX, Python, SolidWorks, Tableau, Fusion360, Minitab
- **Manufacturing:** CNC Machining, 3D Printing, Statistical Process Control (SPC), Technical Documentation, Design of Experiments (DoE), Design for Manufacturing & Assembly (DFMA), Tooling Design, Lean
- **Certification:** Professional Certificate in Electric Cars – TU Delft
- **Spoken Languages:** Fluent in English, Hindi, and Tamil; Intermediate in German (A2)

## PROFESSIONAL EXPERIENCE

### Micro-Nano Mechanical Systems Cleanroom Laboratory

Urbana, IL

Mechanical Engineering Student Assistant

Jan 2024 – May 2024

- Addressed client's wafer yield quality inefficiencies by optimizing the High-NA Photolithography Process.
- Applied Lean and SPC techniques using Minitab for data analysis, improving process efficiency by 10%.
- Evaluated DoE principles to refine process parameters, resulting in improvement of yield quality by 3%.
- Increased SEM imaging accuracy by 20% through sustainable PVD coatings, enhancing material characterization.
- Created technical reports and Tableau dashboards, recommending improved SOPs and input parameters.

### STEM Workshop Instructor

Champaign, IL & Mumbai

Independent Mentoring Volunteer

Oct 2018 – Present

- Devised workshop procedures to streamline delivery and enhance student engagement by 30% in US schools.
- Worked with Teach for India (TFI) to lead a team of eight in delivering STEM-based workshops to 500+ students.
- Volunteered with UIUC's Mechanical Engineering Department to deliver Additive Manufacturing outreach workshops, promoting the undergraduate program to over 50 new high school graduates from Illinois.

### The Aviation & Automobile Blogger – Technical Media Startup

Mumbai, India

Founder

Jan 2019 – May 2023

- Led a team of five, managing content schedules, resources, and project timelines to meet business goals.
- Generated \$5000+ in revenue through advertising, partnerships, social media management, and travel blogging.
- Supervised cross-functional projects, boosting efficiency by 15% through technical research and content strategies.
- Partnered with Lufthansa Technik and BMW India, organizing factory tours to curate informational content.

## PROJECTS & PUBLICATIONS

### Research Publication: A Challenging Future of Industry 4.0—New Technologies and Lean Production Systems

- Co-authored research analyzing the integration of Industry 4.0 technologies and Lean Manufacturing methodologies, published in Springer Nature Singapore, March 2023.

DOI: 10.1007/978-981-19-7971-2\_5

### Digital Twin Model of a Custom Single-Phase Cooling Heat-Sink for Server CPUs

- Developed a Digital Twin Model of AMD EPYC CPU & custom single-phase cooling heat sink using Fusion360.
- Simulated the digital model with ANSYS Icepak using real-time data to improve cooling efficiency by 12%.

### GreenFleetTech – Biomimetic Shark Skin for Electric Semi-Truck Efficiency Improvement

- Increased semi-truck efficiency by 1.5% through drag reduction using biomimetic designs inspired by shark skin.
- Engineered scalable simulations and applications with CFD and Python, evaluating commercial EV feasibility.

### 2020 Boeing's National Aeromodelling Competition – IIT Madras India

- Ranked Top 3 nationwide by leading a team of four to engineer aircraft prototypes with 25 lbs payload capacity.
- Applied DFMA principles to simplify manufacturing and assembly processes, reducing build time by 20%.
- Performed on-spot disassembly & component analysis, refining our design features to outperform our competitors.